

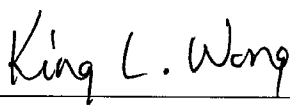
<u>IN THE UNITED STATES PATENT AND TRADEMARK OFFICE</u>			
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT		Docket Number: 12477/13	
Application Number: 10/594,031	Filing Date: September 25, 2006	Examiner: Not Yet Known	Art Unit: 1711
Invention Title: MODIFIER OF POLYESTER RESIN AND PROCESS FOR PRODUCING MOLDED ARTICLE WITH THE SAME		Inventor(s): Kenji Shiga et al.	

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

1. In accordance with their duty of disclosure under 37 C.F.R. §1.56 and in conformance with the procedures of 37 C.F.R. §§ 1.97 and 1.98, applicants hereby submit the information listed in the attached PTO Form SB/08a. The filing of this Information Disclosure Statement (IDS) and the PTO Form SB/08a, shall not be construed as an admission that the information cited is prior art, or is considered to be material to patentability as defined in 37 C.F.R. § 1.56(b).
2. Applicants note that the Japanese publication cited in the PTO Form SB/08a was previously cited in an Office Action dated April 29, 2008 in a related Korean Patent Application No. 10-2006-7020640.
3. Pursuant to 37 C.F.R. §1.97(b)(3), no fees are deemed necessary in connection with this IDS. However, should any fees be due, the Commissioner is authorized to charge any such fees to Kenyon & Kenyon LLP Deposit Account No. **11-0600**.

Respectfully submitted,
KENYON & KENYON LLP

Date: July 16, 2008



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